

Z-PACK | Z-PACK TinMan

TE Internal #: 1934311-1

120 Position High Speed Backplane Connector, 12 Row, 10

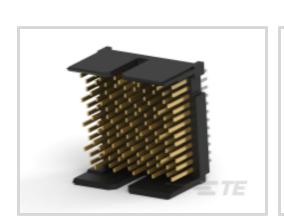
Column, PCB Mount Header, Vertical, Partially Shrouded, Z-PACK

TinMan

View on TE.com >

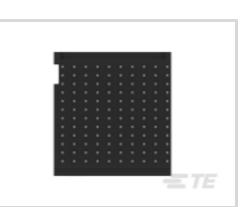


Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors











Number of Positions: 120

Row-to-Row Spacing: 1.4 mm [.055 in]

Mating Alignment: With

Mating Alignment Type: Guide Slot

Number of Rows: 12

Features

Electrical Characteristics

Operating Voltage	250 VAC
Impedance	100 Ω

Signal Characteristics

Data Rate	10 Gb/s
Differential Impedance	100 Ω
Number of Differential Pairs per Column	4

Industry Standards

Compatible With Agency/Standards Products	UL
UL Flammability Rating	UL 94V-0
Compatible With Approved Standards Products	UL E28476

Termination Features

Termination Method to PCB	Through Hole - Press-Fit
Termination Post & Tail Length	2.5 mm[.098 in]



Body Features

Primary Product Color	Black
Packaging Features	
Packaging Method	Tube, Box & Tube
Contact Features	
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]
PCB Contact Termination Area Plating Material Thickness	.5 μm[20 μin]
Contact Shape & Form	Rectangular
Contact Mating Area Plating Material	Gold
Contact Mating Area Length	6 mm[.236 in]
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	.5 A
Housing Features	
Number of Shrouded Sides	2
End Wall Location	Open
Housing Material	LCP (Liquid Crystal Polymer)
Centerline (Pitch)	1.9 mm[.075 in]
Product Type Features	
Signal Arrangement	Differential
Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board
Backplane Module Type	Center
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Partially Shrouded
Mechanical Attachment	
Guide Hardware	Without
PCB Mount Retention	With
Mating Retention	Without
PCB Mount Retention Type	Action/Compliant Tail



PCB Mount Alignment	Without
Mating Alignment	With
Mating Alignment Type	Guide Slot
Connector Mounting Type	Board Mount
Dimensions	
Connector Width	20.2 mm
Connector Height	11.8 mm
PCB Hole Diameter	.47 mm
Connector Length	11.8 mm
Row-to-Row Spacing	1.4 mm[.055 in]
Configuration Features	
Number of Pairs	40
Number of Signal Positions	80
Backplane Architecture	Traditional Backplane
Stackable	No
Pairs per Column	4
Number of Positions	120
Number of Rows	12
Number of Columns	10
PCB Mount Orientation	Vertical
Usage Conditions	
Operating Temperature Range	-65 – 90 °C[-85 – 194 °F]
Operation/Application	
Circuit Application	Signal
Other	
EU RoHS Compliance	Compliant
EU ELV Compliance	Compliant

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant



China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

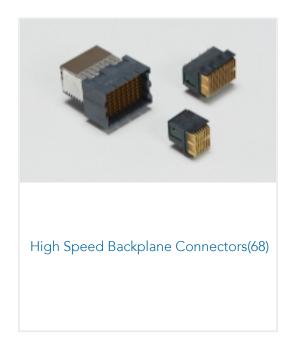
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | Z-PACK TinMan

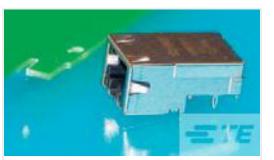


Customers Also Bought

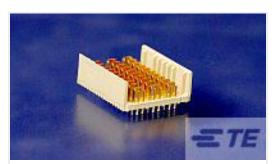




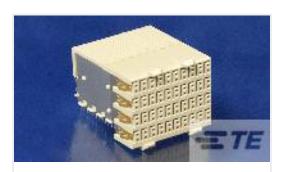
TE Part #1888247-1 20 POS SMT CONN, SFP/SFP+, 30A



TE Part #1888250-4 low profile rj45, 1x1 grn/grn

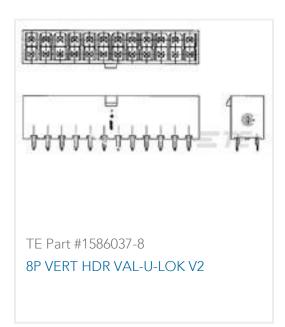


TE Part #6469083-1 HMZD 3PAIR, HDR ASSY, 25MM MOD



TE Part #6469001-1 HM-ZD 4PR RECP 80P













Documents

Product Drawings

Tin Man Header Assy4x10Open

English

CAD Files

Customer View Model

ENG_CVM_1934311-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_1934311-1_A.3d_stp.zip

English

Customer View Model

ENG_CVM_1934311-1_A.2d_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages



High Speed Backplane Connectors catalog - Z-PACK TinMan High Speed, High Density Backplane Connector

English

Product Specifications

Application Specification

English

Agency Approvals

UL Report

English

UL Report

English